

C1210X339DATACAUTO7210

SMD Auto X8G HT150C Flex, Ceramic, 3.3 pF, +/-0.5 pF, 250 VDC, X8G, SMD, MLCC, High Temperature, Ultra-Stable, Automotive Grade, 1210, 1.5



General Information		
Series	SMD Auto X8G HT150C Flex	
Style	SMD Chip	
Description	SMD, MLCC, High Temperature, Ultra-Stable, Automotive Grade	
Features	High Temperature, Ultra-Stable, Automotive Grade	
RoHS	Yes	
Termination	Flexible Termination	
Marking	No	
Qualifications	AEC-Q200	
AEC-Q200	Yes	
Typical Component Weight	30 mg	
Shelf Life	78 Weeks	
MSL	1	

3.3 pF

Dimensions	
Chip Size	1210
L	3.3mm +/-0.4mm
W	2.6mm +/-0.3mm
Т	0.78mm +/-0.20mm
S	1.5mm MIN
В	0.6mm +/-0.25mm

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В	0.6mm +/-0.25mm
Packaging Specifications	

Packaging Packaging

	3.3mm +/-0.4mm	Measurement Condition	1 MHz 1.0Vrms
	2.6mm +/-0.3mm	Tolerance	+/-0.5 pF
	0.78mm +/-0.20mm	Voltage DC	250 VDC
	1.5mm MIN	Dielectric Withstanding Voltage	625 VDC
	0.6mm +/-0.25mm	Temperature Range	-55/+150°C
		Temp. Coefficient	X8G
g Specifications		Capacitance Change with	30 ppm/C, 1MegaHz 1.0Vrms
9	T&R, 330mm, Plastic Tape	Reference to +25°C and 0 VDC Applied (TCC)	
g Quantity 10000	Dissipation Factor	0.1% 1 MHz 1.0Vrms	
	Aging Rate	0% Loss/Decade Hour: Referee Time is 1000 Hours	
		Insulation Resistance	100 GOhms

Specifications Capacitance

Statements of suitability for certain applications are based on our knowledge of typical operating conditions for such applications, but are not intended to constitute - and
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